

**WSP4406** 

**N-Ch MOSFET** 

### **General Description**

The WSP4406 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSP4406 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

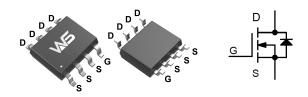
### **Product Summery**

BVDSS	RDSON	ID
30V	9.5mΩ	12A

#### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

### **S0P-8 Pin Configuration**



Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I₀@T₀=25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	12	А
I <sub>D</sub> @T <sub>C</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	10	А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	40	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	25	mJ
I <sub>AS</sub>	Avalanche Current	23	А
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation <sup>4</sup>	3.1	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

# **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>ejA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup>		65	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		20	°C/W

# Absolute Maximum Ratings



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# Electrical Characteristics (T<sub>J</sub>=25<sup>1</sup>C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
$\triangle BV_{DSS} / \triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$ , I_D=1mA		0.023		V/℃
D	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =12A		9.5	12	
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		13	18	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.2	1.9	2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_{D}=250$ uA		-5.08		mV/℃
	Drain Source Lookage Current	$V_{\text{DS}}\text{=}24V$ , $V_{\text{GS}}\text{=}0V$ , $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$			1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =8A		50		S
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.5	3	Ω
Qg	Total Gate Charge (4.5V)			6.3		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =12A		2.9		nC
Q <sub>gd</sub>	Gate-Drain Charge			2.0		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =15V , V <sub>GS</sub> =10V , R <sub>G</sub> =6Ω I <sub>D</sub> =1A ,RL=15Ω		8	14	
Tr	Rise Time			10	17	
T <sub>d(off)</sub>	Turn-Off Delay Time			23	42	ns
T <sub>f</sub>	Fall Time			4.5	12	]
Ciss	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		770	890	
C <sub>oss</sub>	Output Capacitance			130	183	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			76	110	

### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy <sup>5</sup>	V <sub>DD</sub> =25V , L=0.1mH , I <sub>AS</sub> =23A	24.6			mJ

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>				9	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	$V_G = V_D = 0V$ , Force Current			36	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.1	V
t <sub>rr</sub>	Reverse Recovery Time			18		nS
Qrr	Reverse Recovery Charge	l⊧=12A , dl/dt=100A/µs , Tյ=25℃		10		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L}\text{=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=}23\text{A}$ 

4.The power dissipation is limited by 150  $^\circ\!\!\mathbb{C}$  junction temperature

5. The Min. value is 100% EAS tested guarantee.

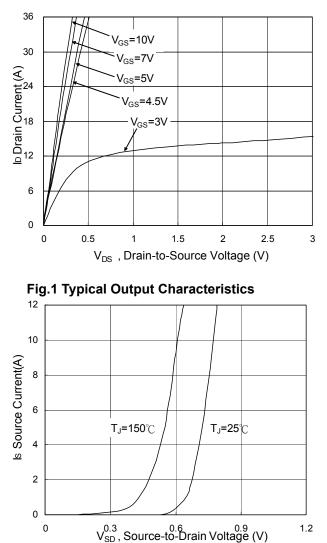
6. The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.

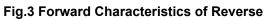


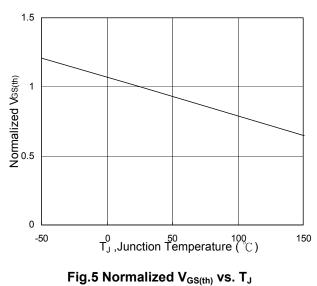
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# **Typical Characteristics**







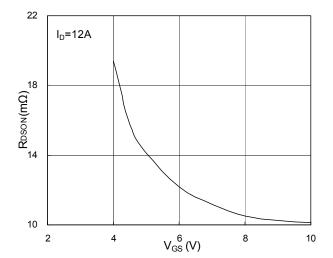


Fig.2 On-Resistance vs. G-S Voltage

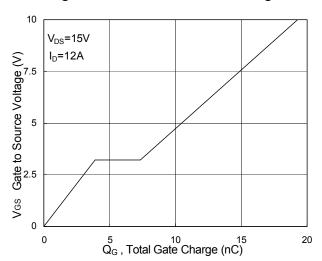


Fig.4 Gate-Charge Characteristics

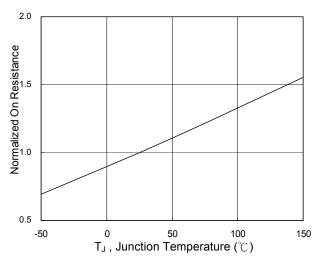
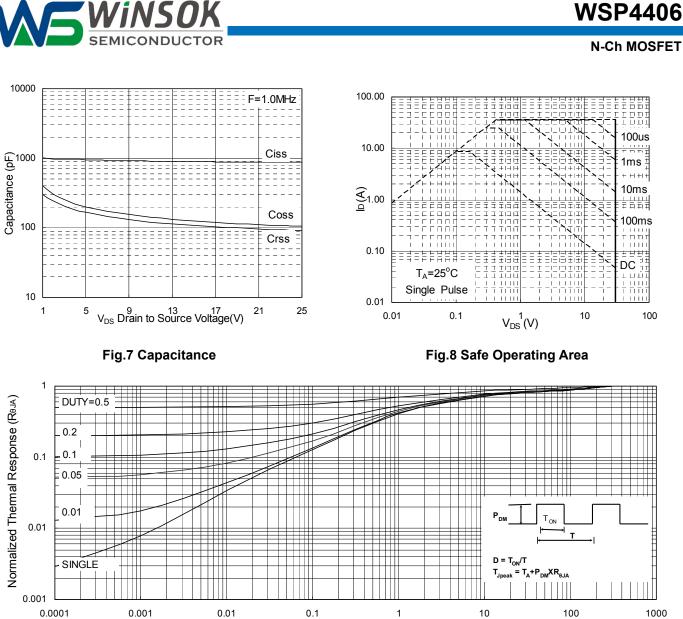


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>

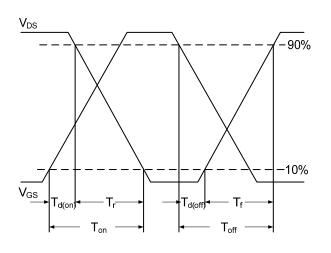
0

1.2



t, Pulse Width (s)







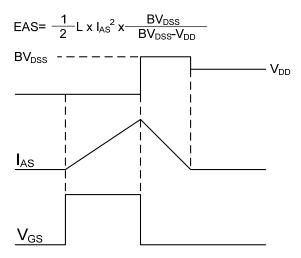


Fig.11 Unclamped Inductive Switching Waveform



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